



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Keyvan Sayyah

) Group Art No.: 2818

) Examiner: Le, Thao P

Application No: 09/924,158

) **Amendment**

Filed: August 7, 2001

) Our Ref: 618935-7/RPB B-3927CIP

) Your Ref: HRL 990801

For: "Method for Fabricating Large Area Flexible
Electronics"

) Date: January 10, 2003

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*Pre-Amend
a
C. Stanley
2-11-03*

Box RCE

**Honorable Commissioner of Patents and Trademarks
Washington, D.C. 20231**

Dear Sir:

This paper is filed with an RCE (Request for Continued Examination) after receipt of a Notice of Allowance (NOA). This paper amends the allowed claims and add new claims. The amendments to the allowed claims do not narrow those claims, but rather amend the claims to use more consistent terminology throughout the claims. The new claims added by this amendment are directed to the subject matter which the examiner indicated as being patentable in the reasons for allowance which accompanied the NOA.

Please amend the presently pending claims to read as indicated below and add new claims 22 -

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34 to this application. A marked set of claims showing the changes made can be found in the appendix to this response.

1. (Amended) A method for transferring circuit elements originally supported by an original substrate to locations on a new substrate, said method comprising steps of:

(a) providing said original substrate with a release member disposed upon a surface of said original substrate, said circuit elements being fabricated on a top surface of said release member;

al (b) defining individual elements about said circuit elements, said individual elements preferably having a conical frustum-shaped configuration;

(c) fabricating a first set of electrically conductive contacts on a surface of said individual elements, said first set of electrically conductive contacts being preferably concentrically disposed rings defining space therebetween;

(d) freeing said individual elements by removing said release member;

(e) defining receptors in said new substrate, said receptors having a bottom surface and sloping side walls, said receptors being sized to receive said individual elements;

(f) fabricating a second set of electrically conductive contacts on said bottom surface, said second set of electrically conductive contacts being concentrically disposed rings defining space therebetween, said second set of electrically conductive contacts
